McMAHON
ENGINEERS ARCHITECTS

To: **The Village President and Board of Trustees**

From: **Chris Dopkins, P.E., Village Engineer**

Re: **Engineering Report – February Activity**

Date: **March 3, 2021**

Please allow this memorandum to provide a brief summary of major activity over the past month that involves the engineering department:

- **Washington/Main Improvements:** We are pleased to advise that ComEd has completed its work and the Contractor is planning to be back on site in the next two weeks to install the pumps. Restoration work will be done once weather cooperates in the spring.
- **Sanitary Sewer Cleaning/Televising Phase II:** Visu-Sewer has provided the video for the manholes and sanitary sewers which have been evaluated. We expect to deliver the final report to the Village within the next week or so.
- **Public Works Building:** As you will recall, the Village is utilizing grant funds in the amount of $200,000 to help offset the cost of the building, and that those funds are being distributed to the County who will then distribute the funding the Village. As I reported in the past, the County was notified that DCEO was beginning to write the grant agreement, and as of the date of this memo the grant agreement has not yet arrived at the County. However, DCEO did reach out to the County with questions on the application so we know that DCEO is indeed working on the agreements. Once the grant agreement is presented the County will determine if IGA's are necessary for the distribution of funds, and we can complete the front-end documents of the specification and can let the project for public bid letting.
- **2021 Maintenance Program:** Due to poor weather conditions and snow cover, field work for the 2021 maintenance program has not yet begun. We expect to complete the field work the week of March 8th and turn a draft packet into IDOT the week of March 15th. A resolution authorizing bidding is on the agenda for the March Finance and Board meeting so that we can advertise after receipt of IDOT approval.